(2.54 mm) .100"



NO. PINS

PER ROW

PLATING

OPTION

-G

= 20 μ" (0.51 μm)

Gold

-Т

= Tin

STYLE

MACHINED BOARD STACKING STRIPS

(2.54) .100 x No. of Positions

BBL body available with Styles –E & –F only.

 \bigcirc

←(2.54) .100 TYF

TYPE

STRIP

BBS

= Standard Single Row

 BBL

= Low-Profile Single Row

Mates with:

SS, SD, HSS, SL, SDL, ESS, ESD

FEATURES

- Low-profile design achieves (3.89 mm) .153" board spacings when mated with SL Series.
- Approach the reliability of a permanent connection with the flexibility of a separable connection.

SPECIFICATIONS

For complete specifications see www.samtec.com?BBS, www.samtec.com?BBL, www.samtec.com?BHS www.samtec.com?BBD or www.samtec.com?BDL

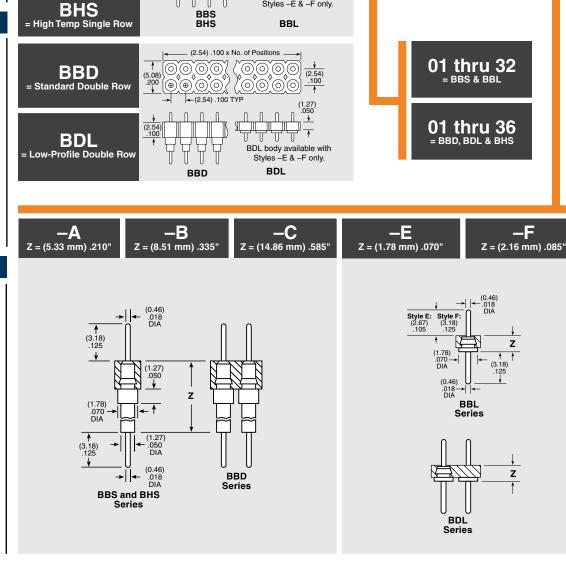
Insulator Material:
Black Liquid Crystal Polymer (BBL, BHS)
Black Glass Filled Polyester (BBS, BBD, BDL)
Temperature Range:
-55 °C to +125 °C
Terminal Material:
Phosphor Bronze or Brass

Plating:
Au or Sn over
50 µ" (1.27 µm) Ni
Lead-Free Solderable:
Yes (BBL, BDL, BHS-S)
No, Lead Wave only
(BBS, BBD, BHS-N)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





Note:

Some lengths, styles and options are non-standard, non-returnable.